



INFORMATION DISCLOSURE CITATION

(Use several sheets if necessary)

ATTY DOCKET NO.

11675.184.1

SERIAL NO.

10/033.233

Salman Akram

FILING

December 28, 2001

GROUP

Unknown 2823

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
KN	1.	6,011,304	1/2000	Mertol	257	706	05/05/97
KN	2.	6,215,180	4/2001	Chen, et al.	257	720	03/17/99
KN	3.	5,583,378	12/1996	Marrs, et al.	257	710	05/16/94
KN	4.	6,175,157	1/2001	Morifuji	257	777	03/20/98
KN	5.	6,218,202	4/2001	Yew, et al.	438	15	10/06/98
KN	6.	5,907,189	5/1999	Mertol	257	787	05/29/97
KN	7.	5,786,631	7/1998	Fishley, et al.	257	701	10/04/95
KN	8.	5,930,893	8/1999	Eaton	28	890.03	05/29/96
KN	9.	5,843,810	12/1998	Sato, et al.	438	123	01/31/97
KN	10.	5,834,337	11/1998	Unger, et al.	438	122	03/21/96
KN	11.	5,475,040	12/1995	Jamison, et al.	536	513	06/14/94

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
KN	12.	JP362023138A	1/1987	Japan			✓	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

KN	13.	R. Hundadi, et al., "High Thermal Conductivity Greases," pp. 28-32, Advanced Packaging, April 1999.
----	-----	---

EXAMINER

K. H. H. H. H. H.

DATE CONSIDERED

12/26/02

(Use several sheets if necessary)

SERIAL NO. 10/033,233

FILING
December 28, 2001

GROUP	Unknown 2823
-------	--------------

[illegible][illegible]

DATE CONSIDERED

Kreuzungen

12/26/02